

KSP25/26/27

Darlington Transistor

Collector-Emitter Voltage: V_{CES}=KSP25: 40V
KSP26: 50V

KSP27: 60V

• Collector Power Dissipation: P_C (max) =625mW



NPN Epitaxial Silicon Darlington Transistor

Absolute Maximum Ratings T_a=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CES}	Collector-Emitter Voltage		
	: KSP25	40	V
	: KSP26	50	V
	: KSP27	60	V
V _{EBO}	Emitter-Base Voltage	10	V
l _C	Collector Current	500	mA
P _C	Collector Power Dissipation	625	mW
TJ	Junction Temperature	150	°C
T _{STG}	Storage Temperature	-55~150	°C

Electrical Characteristics T_a =25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
BV _{CES}	Collector-Emitter Breakdown Voltage	I _C =100μA, I _E =0			
	: KSP25		40		V
	: KSP26		50		V
	: KSP27		60		V
BV _{CBO}	Collector-Base Breakdown Voltage	I _C =100μA, I _E =0			
	: KSP25		40		V
	: KSP26		50		V
	: KSP27		60		V
I _{CBO}	Collector Cut-off Current				
	: KSP25	$V_{CE}=30V$, $I_{E}=0$		100	nA
	: KSP26	$V_{CE}=40V$, $I_{E}=0$		100	nA
	: KSP27	$V_{CE} = 50V, I_{E} = 0$		100	nA
I _{EBO}	Emitter Cut-off Current	V _{EB} =10V, I _B =0		100	nA
h _{FE}	* DC Current Gain	V _{CE} =5V, I _C =10mA	10K		
		$V_{CE}=5V$, $I_{C}=100$ mA	10K		
V _{CE} (sat)	* Collector-Emitter Saturation Voltage	I _C =100mA, I _B =0.1mA		1.5	V
V _{BE} (on)	* Base-Emitter On Voltage	V _{CE} =5V, I _C =100mA		2	V

^{*} Pulse Test: PW≤300μs, Duty Cycle≤2%

Typical Characteristics

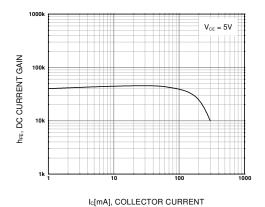


Figure 1. DC current Gain

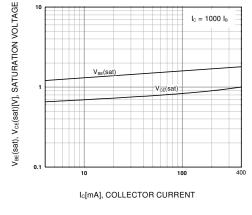


Figure 2. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

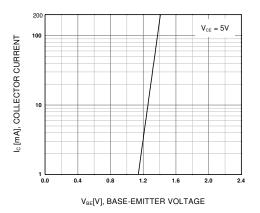


Figure 3. Base-Emitter On Voltage

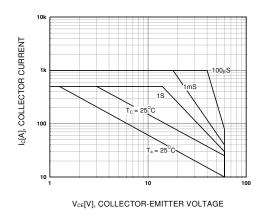
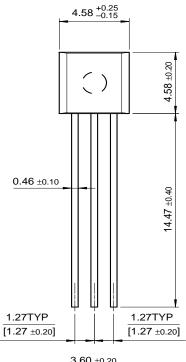
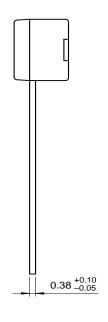


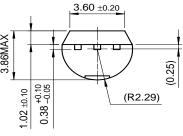
Figure 4. Safe Operating Area

Package Dimensions

TO-92







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